



Customer:

LCD MODULE

MODULE NO.:

KSEGG12864-58 SERIES

Approved by:								
Approved by	Checked by	Prepared by						

RECORDS OF REVISION

Part Number	Revision	Revision Content	Revised on
KSEGG12864-58	00	First issue	June. 20th, 2016

Version: 00 ______ 2

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1. FUNCTIONS & FEATURES

• KSEGG12864-58 Series LCD type:

Module	LCD Type	Remark
KSEGG12864-58 FWZ	FSTN Transflective Positive Mode	

• Display Contents :128 x 64 Dots

• Driving Scheme : 1/65Duty; 1/9Bias

• Viewing Direction :6 O' clock

• Power Supply Voltage : 3.0V.

• Driver IC :ST7567S

• Interface :Parallel/SPI

• Backlight :white

• Operating Temperature :- 20°C - + 70°C

• Storage Temperature :- 30° C - + 80° C

RoHS Compliant

KSE
 KEEN SIDE electronics

2. MECHANICAL SPECIFICATIONS

• Outline Dimensions : 63.20(W) x 41.70(L) x 5.10(H)(mm)

• Viewing Area : 50.00 (W) x 25.00(L)(mm)

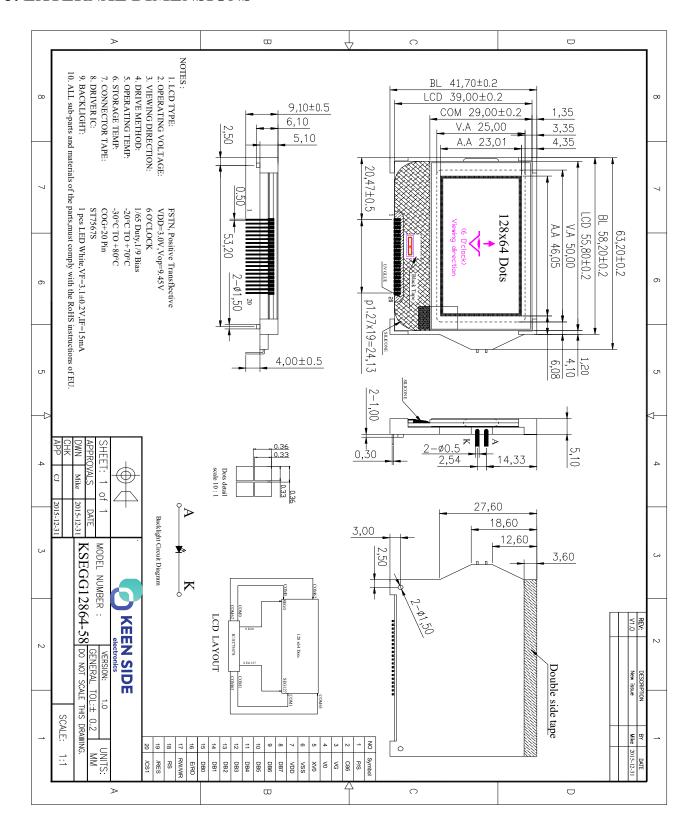
• Active Area : 46.05 (W) x 23.01 (L)(mm)

• Dot Pitch : 0.36 (W) x 0.36 (L)(mm)

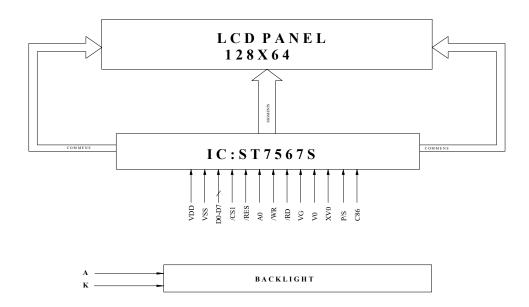
• Dot Size : 0.33 (W) x 0.33 (L)(mm)

• Weight : TBD

3. EXTERNAL DIMENSIONS



4. BLOC'K DIAGRAM



5. PIN ASSIGNMENT

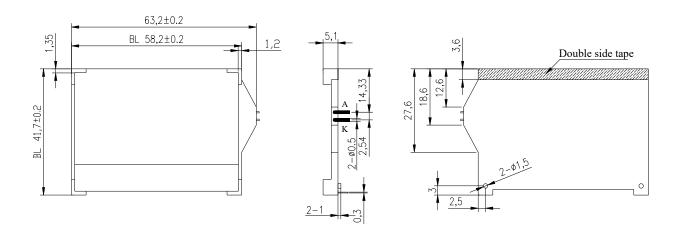
Pin No.	Symbol	Function
1	P/S	This pin configures the interface to be parallel mode or serial mode.
1	17/3	P/S = "H": Parallel data input/output. P/S = "L": Serial data input.
2	C86	This is the MPU interface selection pin.
<i>L</i>	C80	C86 = "H": 6800 Series MPU interface. C86 = "L": 8080 Series MPU interface.
		VG is the LCD driving voltage for segment circuits.
3	VG	Vgout is the output of VG regulator. VG is the feedback of VG regulator.
		Vgin is the VG input of segment circuits.
		XV0 is the LCD driving voltage for common circuits at positive frame.
4	V0	XV0out is the output of XV0 regulator. XV0s is the feedback of XV0 regulator.
		XV0in is the V0 input of common circuits.
		V0 is the LCD driving voltage for common circuits at negative frame.
5	XV0	V0out is the output of V0 regulator. V0s is the feedback of V0 regulator.
		V0in is the V0 input of common circuits.
6	VSS	Ground terminal of module.
7	VDD	Power terminal of module
		This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus.
		When the serial interface (SPI-4) is selected ($P/S = "L"$):
8-15	D7-D0	D7: serial data input (SI); D6: the serial clock input (SCL).
		D0 to D5 should be connected to VDD or floating.
		When the chip select is not active, D0 to D7 are set to high impedance.
		• When connected to 8080 series MPU, this pin is treated as the "/RD" signal of the 8080
1.6	/DD/E)	MPU and is LOW-active. The data bus is in an output status when this signal is "L".
16	/RD(E)	• When connected to 6800 series MPU, this pin is treated as the "E" signal of the 6800
		MPU and is HIGH-active. This is the enable clock input terminal of the 6800 Series MPU.
		• When connected to 8080 series MPU, this pin is treated as the "/WR" signal of the 8080 MPU
		and is LOW-active. The signals on the data bus are latched at the rising edge of the /WR signal.
17	/WR(R/W)	• When connected to 6800 series MPU, this pin is treated as the "R/W" signal of the 6800
		MPU and decides the access type:
		When $R/W = "H"$: Read. When $R/W = "L"$: Write.
		This is connecting to the least significant bit of the normal MPU address bus, and it determines
1.0	D.C.	whether the data bits are data or command.
18 RS		RS = "H": Indicates that D0 to D7 are display data.
		RS = "L": Indicates that D0 to D7 are control data.
10	/DEC	When /RES is set to "L", the register settings are initialized (cleared).
19	/RES	The reset operation is performed by the /RES signal level.
20	/CS1	This is the chip select signal.
	LEDA	Anode of Backlight
	LEDK	Cathode of Backlight

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6. BACKLIGHT ELECTRICAL/OPTICAL SPECIFICATIONS

Electrical/Optical Specifications

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Forward Voltage	Vf	2.9	3.1	3.3	V	If= 15 x1 mA
Reverse Current	Ir			120	mA	Vr=5.0 V
Power Dissipation	Pd			275	mW	If= 15 x1 mA
Dominant vyaya lanath	X		0.299	0.33		If= 15 x 1 mA
Dominant wave length	Y		0.313	0.33	-	11– 13 X I MA
Luminous	LV	85			cd/m2	If= 15 x 1 mA
Luminous Uniformity	△Lv	70			%	If= 15 x 1 mA



7. MAXIMUM ABSOLUTE POWER RATINGS

Item	Symbol	Standard value	Unit
Power supply voltage(1)	VDD	-0.3~+3.6	V
Power supply voltage(2)	VOUT,, V0,	- 0.3 ∼ 13.5	V
Power supply voltage(3)	VIN	-0.3 ~ V0	V
Operating temperature	Topr	-20~+70	${\mathbb C}$
Storage temperature	Tstg	-30~+80	${\mathbb C}$

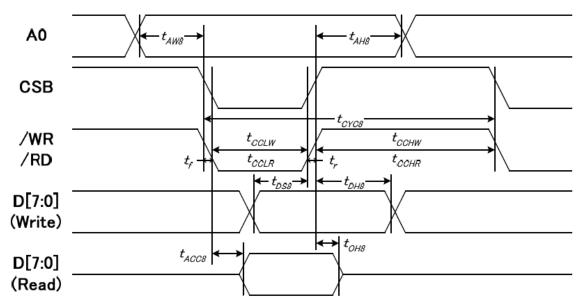
8. ELECTRICAL CHARACTERISTICS

8-1 DC Characteristics

Itom	Cymbol	Sta	ndard Va	alue	Test	Unit	
Item	Symbol	Min	Тур	Max	Condition		
Operating Voltage	V _{DD} -Vss	2.8	3.0	3.2	TA=25℃	V	
Supply Current	I_{DD}		TBD	5.0		mA	
LCD Driving Voltage	V ₀ -V _{ss}	9.25	9.45	9.65	TA=25°C	V	

8-2 AC Characteristics

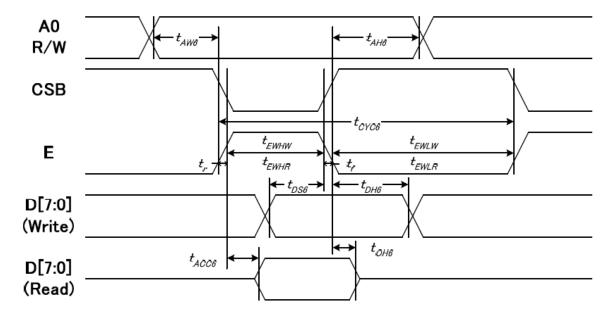
8.2.1 Read/Write mode for the 8080 Series MPU



 $(VDD1 = 3.3V, Ta = 25^{\circ}C)$

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW8		0	_	
Address hold time	AU	tAH8		10	_	
System cycle time		tCYC8		240	_	
/WR L pulse width (WRITE)	WR	tCCLW		80	_	
/WR H pulse width (WRITE)		tCCHW		80	_	
/RD L pulse width (READ)	RD	tCCLR		140	_	ns
/RD H pulse width (READ)	KD.	tCCHR		80		
WRITE Data setup time		tDS8		40	_	
WRITE Data hold time	D(7:01	tDH8		20	_	
READ access time	D[7:0]	tACC8	CL = 16 pF	_	70	
READ Output disable time		tOH8	CL = 16 pF	5	50	

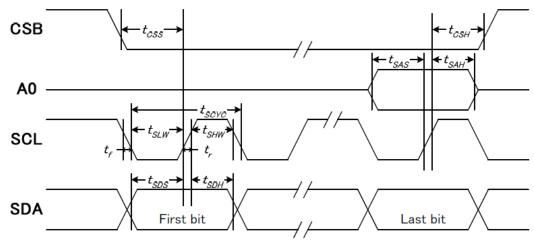
8.2.2 Read/Write mode for the 6800 Series MPU



 $(VDD1 = 3.3V, Ta = 25^{\circ}C)$

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Address setup time	A0	tAW6		0	_	
Address hold time	AU	tAH6		10	_	
System cycle time		tCYC6		240	_	
Enable L pulse width (WRITE)		tEWLW		80	_	
Enable H pulse width (WRITE)	E	tEWHW		80	_	
Enable L pulse width (READ)		tEWLR		80	_	ns
Enable H pulse width (READ)		tEWHR		140		
Write data setup time		tDS6		40	_	
Write data hold time	D(7:01	tDH6		10	_	
Read data access time	D[7:0]	tACC6	CL = 16 pF	_	70	
Read data output disable time		tOH6	CL = 16 pF	5	50	

8.2.3 Read/Write mode for 4-SPI Series MPU



 $(VDD1 = 3.3V, Ta = 25^{\circ}C)$

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period		tSCYC		50	_	
SCLK "H" pulse width	SCLK	tSHW		25	_	
SCLK "L" pulse width		tSLW		25	_	
Address setup time	4.0	tSAS		20	_	
Address hold time	- A0	tSAH		10	_	ns
Data setup time	SDA	tSDS		20	_	
Data hold time	SDA	tSDH		10	_	
CSB-SCLK time	CSB	tCSS		20	_	
CSB-SCLK time	CSB	tCSH		40	_	

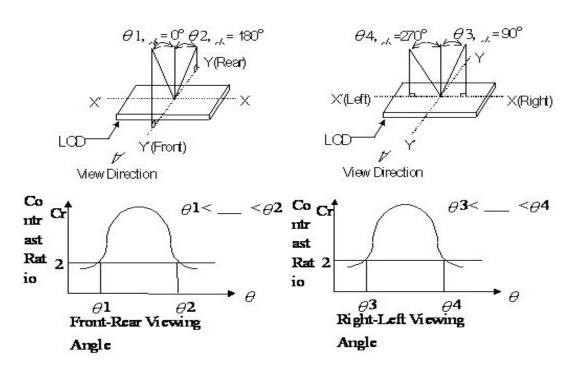
9. INSTRUCTION TABLE

		R/W	COMMAND BYTE								
INSTRUCTION	A0	(RWR)	D7	D6	D5	D4	D3	D2	D1	D0	DESCRIPTION
(1) Display ON/OFF	0	0	1	0	1	0	1	1	1	D	D=1, display ON D=0, display OFF
(2) Set Start Line	0	0	0	1	S5	S4	S3	S2	S1	S0	Set display start line
(3) Set Page Address	0	0	1	0	1	1	Y3	Y2	Y1	Y0	Set page address
(4)	0	0	0	0	0	1	X7	X6	X5	X4	Set column address (MSB)
Set Column Address	0	0	0	0	0	0	X3	X2	X1	X0	Set column address (LSB)
(5) Read Status	0	1	0	MX	D	RST	0	0	0	0	Read IC Status
(6) Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write display data to RAM
(7) Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read display data from RAM
(8) SEG Direction	0	0	1	0	1	0	0	0	0	MX	Set scan direction of SEG MX=1, reverse direction MX=0, normal direction
(9) Inverse Display	0	0	1	0	1	0	0	1	1	INV	INV =1, inverse display INV =0, normal display
(10) All Pixel ON	0	0	1	0	1	0	0	1	0	AP	AP=1, set all pixel ON AP=0, normal display
(11) Bias Select	0	0	1	0	1	0	0	0	1	BS	Select bias setting 0=1/9; 1=1/7 (at 1/65 duty)
(12) Read-modify-Write	0	0	1	1	1	0	0	0	0	0	Column address increment: Read:+0 , Write:+1
(13) END	0	0	1	1	1	0	1	1	1	0	Exit Read-modify-Write mode
(14) RESET	0	0	1	1	1	0	0	0	1	0	Software reset
(15) COM Direction	0	0	1	1	0	0	MY	-	-	-	Set output direction of COM MY=1, reverse direction MY=0, normal direction
(16) Power Control	0	0	0	0	1	0	1	VB	VR	VF	Control built-in power circuit ON/OFF
(17) Regulation Ratio	0	0	0	0	1	0	0	RR2	RR1	RR0	Select regulation resistor ratio
(18) Set EV	0	0	1	0	0	0	0	0	0	1	Double command!! Set
(10) Set EV	0	0	0	0	EV5	EV4	EV3	EV2	EV1	EV0	electronic volume (EV) level
	0	0	1	1	1	1	1	0	0	0	Double command!!
(19) Set Booster	0	0	0	0	0	0	0	0	0	BL	Set booster level: BL=0: 4X BL=1: 5X
(20) Power Save	0	0	Compound Command				Display OFF + All Pixel ON				
(21) NOP	0	0	1	1	1	0	0	0	1	1	No operation
(22) Test	0	0	1	1	1	1	1	1	1	-	Do NOT use. Reserved for testing.

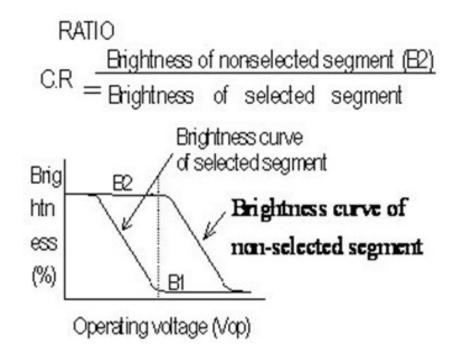
Note: Symbol "-" means this bit can be "H" or "L".

10. Optical Characteristics

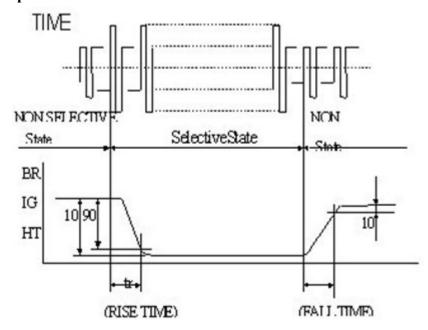
10.1 Definition of Viewing Angle



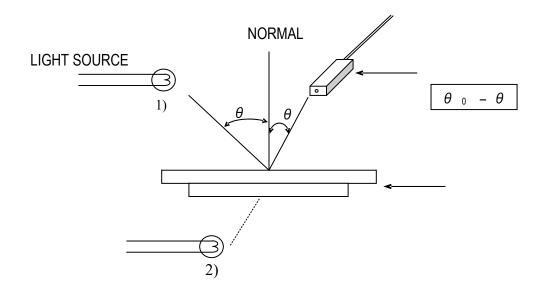
10.2 Definition of Contrast



10.3 Definition of Response



10.4 Measuring Instruments For Electro-optical Characteristics



* Note:

- 1) Light source position for measuring the reflective type of LCD panel;
- 2) Light source position for measuring the transflective / transmissive types of LCD panel.

11. MODULE ACCEPT QUALITY LEVEL (AQL)

11.1 AQL Standard Value: Critical Defect =0.1, Major Defect=0.65; Minor Defect =2.5

11.2 Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II

12. RELIABILITY TEST

Operating life time: Longer than 75,000 hours

(at room temperature without direct irradiation of sunlight)

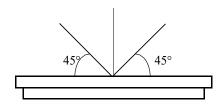
Reliability characteristics shall meet following requirements.

No.	Test Item	Content of Test	Test Condition	
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	+80°C 96H	
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	−30°C 96H	
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	+70°C 96H	
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	−20°C 96H	
5	High Temperature/ Humidity Storage	Endurance test applying the high temperature and humidity storage for a long time	60°C 90%RH 96H	
6	Temperature Cycle	Endurance test applying the low and high temperature cycle $-20^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C} \longleftrightarrow 70^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C}$ $30\text{min} 5\text{min} 30\text{min} 5\text{min}$ $\longleftrightarrow 1 \text{ cycle}$	-20°C/70°C 5 cycles	
7	Vibration Test (Package State)	Endurance test applying the vibration during transportation	10Hz - 55Hz, 50m/s, 15min	
8	Shock Test (Package State)	Endurance test applying the shock during transportation	Half-sinewave, 100m/s, 11ms	
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	40 kPa 16 H	

13. Inspection specification

13.1 Visual Inspection

- 1) Inspect under 2x20W or 40W fluorescent lamp (approximately 3000 lux) leaving 25 to 30 cm between the module and the lamp and 30 cm between the module and the eye (measuring position).
- 2) Appearance is inspected at the best contrast voltage (best contrast is adjusted considering clearness and crosstalk on screen).
- 3) Inspect the module at 45° right and left, top and bottom.
- 4) Use the optimum viewing angle during the contrast inspection.



13.2 Standard of Appearance Inspection

No.	Item	Criteria						
	<i>'</i> /////	Round type: as per following drawing						
			///////////////////////////////////////	Ac	Acceptable quantity			
				Size	Zone A	Zone B		
				Ф<0.1	Any number			
				0.1<Ф<0.2	2	Any number		
			X ////////	0.2<Ф<0.25	1	Any number		
				0.25<Ф	0			
	Line type: as per following drawing Acceptable quantity							
	Black spot		Length	Width	Zone A	Zone B		
1	White spot		_	W≤0.02	Any num ber	Any		
	Dust	L≤3.0	0.02 <w≤0.03< td=""><td>2</td><td>nu</td></w≤0.03<>	2	nu			
		L≤2.5	0.03 <w≤0.05< td=""><td></td><td>mb</td></w≤0.05<>		mb			
			_	0.05 <w< td=""><td>As round type</td><td>er</td></w<>	As round type	er		
		7	L W	e quantity: 3				
2	Polariser	Scratch on protective film is permitted						

	scratch	Scratch on polariser: sa	me as No. 1			
	<i>'///////</i>	///////////////////////////////////////				
				Acceptable quantity		
		////X////X////	G:			
		X	Size	Zone A	A Zone B	
				Any		
				n	u	
			Ф<0.	2 n	n	
3	Polariser			b	e	
3	bubble	Total acceptable		1	Any	
		quantity: 3	0.2< ₵		nu	
			<(mb	
			5		er	
			0.5< ₵	>		
			<]	1.		
			0)		
			1.0< ₵	0		
		4.1 Pin hole on segmen		<u> </u>	<u> </u>	
			ited display			
		W: segment width				
		$\Phi = (A+B)/2$				
				A 4 . 1 . 1		
				Acceptable qua		
			Width		Quantity	
			W≤0.4	$\Phi \leq 0.2$ and Φ		
			W <u>~</u> 0. 4		≤1/2W	
				Ф≤0.25	and	
			W>0.4	Φ≤1/3V		
			Total accepta	able quantity: 1		
			segmen		F	
		4.2 Pin hole on	Pin holes	es with Φ under 0.10 mm		
		dot matrix	acceptal	ble		
		display	•			
			_			
	Segment	₩ ≤0.ú)5	Accep	table quantity	
4	deform			Size		
	ation	८ वे	79		Any	
		73			nu	
		1		a, b<0.1		
				a, b<∪.1		
		m d			be	
		Total acceptable quanti	ty: 7		r	
					Any	
		4.3 Segments / dots wi	th different		nu	
		width		(a+b)/2≤0	.1 m	
		-		\	be	
		D - U			r	
			-	0.5<Ф	1	
					3	
			<1.0)	
		A B		Accepta	able	
	a≥b					
				a≥b	a/b≤4/3	
				a≥b a <b< td=""><td>$a/b \le 4/3$ $a/b > 4/3$</td></b<>	$a/b \le 4/3$ $a/b > 4/3$	

LUU1200	74-30 SERIE				110	uuci	Specifici	
		$\Phi = (A -$	+B)/2					
		20 700						
		by b		Acceptable quantity				
				Size Size				
			, <u> </u>	5120		Any		
		В	/ **			nu		
			No.	⊅ ≤0.4		m		
		\otimes		4			be	
							r	
			- L	0	.4<Ф			
					≤1.		5	
		Total acc	ceptable quan	tity: 7	0			
			1	Ф>0.				
					≤1.		3	
					5			
				1	.5<Ф			
					≤2.		2	
					0			
	Colour	Level of sample for approval set as limit sample						
5	unifor							
	mity							
6	D = -1-1: -1-4	The backlight colour should correspond to the product specification Flashing and or unlit backlight is not allowed						
6	Backlight	Dust larger than 0.25 mm is not allowed						
		Exposed wire bond pad is not allowed						
7	COB	Insufficient covering with resin is not allowed (wire bond line						
,	СОВ	exposed) Dust or bubble on the resin are not allowed						
	РСВ	No unmelted solder paste should be present on PCB						
		Cold solder joints, missing solder connections, or oxidation are not						
8		allowed						
		No residue or solder balls on PCB are allowed						
		Short circuits on components are not allowed						
				Acceptable qua	ntity			
				Size	Qua	ntity		
			On		A	ny		
			t	Ф<0.2		nu		
	_			₩ \0.2		mb		
			a			er		
	Tray		у	Ф>0.25		4		
9	particle s		On	Φ ≥0.25	2	2		
			d					
			i					
			S	Ŧ ^		.		
			p	L=3		1		
			a					
			у					

14. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0

°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

15. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections